

STLVDS3486

High speed differential line drivers

Feature summary

- meets or exceeds the requirements of ansi TIA/EIA-644 standard
- Operates with a single 3.3V supply
- Designed for signaling rate up to 400Mbps
- Differential input thresholds ±100mV max
- Typical propagation delay time of 2.5ns
- Power dissipation 60mW typical per receiver at 200MHz
- Low voltage TTL (LVTTL) logic output levels
- Pin compatible with the MC3486 and SN65LVD3486
- Open circuit fail safe
- ESD protection: 7KV receiver pins 3KV all pins vs gnd

Description

The STLVDS3486, is a differential line receiver that implements the electrical characteristics of low voltage differential signaling (LVC.3). This signaling technique lowers the output voltage levels of 517 differential standard levels (such as TIA/EIA-122B) to reduce the power, increase the switching speeds and alrow operations with a C 3V supply rail. This differential receiver provides a valid logical or light state with a 3.3V supply rail.



It also provides a valid logical putput state with a ±100mW chilerential input volvage within the input common mode voltage range. The input common incide voltage allows 1V of ground potential difference between two LVDS nodes.

The interded application of this device and signaling technique is both point-to-point and rected op data transmission over controlled impedance media approximately 100Ω . The transmission media may be printed circuit board traces, backplanes or cables. The ultimate rate and distance of data transfer depend upon the attenuation characteristics of the media and noise coupling to the environment.

The STLVDS3486 version is characterized for operation from -40°C to 85° C.

Order code

Part number	Temperature Range	Package	Comments
STLVDS3486BTR	-40 to 85 °C	TSSOP16 (Tape & Reel)	2500 parts per reel
April 2006		Rev. 4	1/15

Contents

1	Pin configuration
2	Logic diagram
3	Maximum ratings
4	Electrical characteristics
5	Test circuit
6	Typical performance characteristics
7	Package mechanical data
8	Revision history
obsole obsole	ate Product(s) Obsoleter



Pin configuration 1

Figure 1.	Pin connections
-----------	-----------------



Table 1. **Pin description**

Pin n°	Symbol	Name and function
2, 6, 10, 14	1A to A	Receiver inputs
1, 7, 9, 15	12 to 4B	Negated receiver inputs
3, 5, 11, 13	1Y to 4Y	Receiver outputs
4	1EN, 2EN	Receivers 1 and 2 enable
12	3EN, 4EN	Receivers 3 and 4 enable
	GND	Ground
16	V _{cc}	Supply voltage

Taple 2. Truth table

Differential input	Enables	Output
A, B	EN	Y
V _{ID} ≥ 100mV	Н	Н
-100mV < V _{ID} < 100mV	Н	?
$V_{ID} \le -100 mV$	Н	L
Х	L	Z
OPEN	Н	Н

L=Low level, H=High Level, X=Don't care, Z= High Impedance



2 Logic diagram



Figure 2. Logic diagram and logic symbol

3 Maximum ratings

Symbol	Parameter		Value	Unit
V _{CC}	Supply voltage (Note 1)		-0.5 to 4.6	V
VI	Input voltage	Input voltage		V
VI	Input voltage (A or B inputs)	Input voltage (A or B inputs)		V
ESD	Human body model	Pins receivers	7	КV
ESD	Thuman body model	All pins vs gnd	3	
T _{stg}	Storage temperature range		-65 to +150	Se

Table 3. Absolute maximum ratings

Note: Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied

Note: 1 All voltages except differential I/O bus voltage, are with respect to the network ground terminal.

Symbol	Parameter	Min.	Тур.	Max.	Unit
V _{CC}	Supply voltage	3.0	3.3	3.6	V
V _{IH}	HIGH Level input voltage (enable)	2.0			V
V _{IL}	LOW Level input voltage (enable)	00		0.8	V
V _{ID}	Magnitude of diffe.e.tic Imput voltage	0.1		0.6	V
	Common parts insuit voltage	0.5 V _{ID}		2.4-0.5 V _{ID}	V
V _{IC}	Common n.occ input voltage			V _{CC} - 0.8	
Т _Ј	O,vorating temperature range	-40		85	°C
Obsoli Obsoli	ste Proot				

Table 4. Recommended operating conditions



4 Electrical characteristics

Table 5. Electrical characteristics

⁽Over recommended operating conditions unless otherwise noted. All typical values are at $T_A = 25^{\circ}$ C, and $V_{CC} = 3.3$ V).

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{ITH+}	Positive Going Differential Input Voltage Threshold				100	mV
V _{ITH-}	Negative Going Differential Input Voltage Threshold		-100		-	mV
V	High Level Output Voltage	I _{OH} = -8mA	2.4		10	
V _{OH}	light Level Output voltage	I _{OH} = -4mA	2.8		773	v
V _{OL}	Low Level Output Voltage	I _{OH} = 8mA		20	0.4	V
I	Supply Current	Enabled, No Load	10	10	18	mA
I _{CC}	Supply Current	Disabled	- <u></u>	0.25	0.5	mA
1	Input Current (A or D inpute)	V _I = 0V	-2	-10	-20	^
I,	Input Current (A or B inputs)	V ₁ = 2.4V	-1.2	-3		μA
I _{I(OFF)}	Power off Input Current (A or B inputs)	$V_{\rm CC} = 0, V_1 = 3.6 V$		10	20	μA
I _{IH}	High Level Input Current (EN, G, \overline{G} or Inputs)	$V_{ln} = 2V$			10	μA
Ι _{ΙL}	Low Level Input Current (EN, G, C or Inputs)	V _{IL} = 0.8V			10	μΑ
I _{OZ}	High Impedance Output Current	$V_0 = 0 \text{ or } V_{CC}$			± 10	μA

High Impedance Output C Irr ant

Table 6. Switching characteristics

(Over recommended operating conditions unless otherwise noted. All typical values are at $T_A = 25^{\circ}C$, and $V_{CC} = 3.3V$).

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{PLH}	Propagation Delay Time, Low to High Output		1.5	2.5	3.3	ns
t _{PHL}	Propagation Delay Time, High to Low Output		1.5	2.5	3.3	ns
t _r	Differential Output Signal Rise Time			0.4		ns
t _f	Differential Output Signal Fall Time	C _L = 10pF, Fig. 1		0.4		าร
t _{sk(O)}	Channel to Channel Output Skew (note1)			0.1	03	ns
t _{sk(P)}	Pulse Skew (t _{PHL} - t _{PLH}) (note2)		. (٦.2	0.4	ns
t _{sk(PP)}	Part to Part Skew (note3)		20		1	ns
t _{PZH}	Propagation Delay Time, High Impedance to High Level Output	ete		3	12	ns
t _{PZL}	Propagation Delay Time, High Impedance to Low Level Output		05	5	12	ns
t _{PHZ}	Propagation Delay Time, High Level to High Impedance Output	Fig. 2		5	12	ns
t _{PLZ}	Propagation Delay Time, Low Level to High Impedance Output	sole		5	12	ns

Note: 1 $t_{sk(O)}$ is the maximum delay time difference between the propagation delay of one channel and that of the oners on the same chip with any event on the inputs.

- $t_{sk(P)}$ is the magnitude difference in differential propagation delay time between the positive going cige and the negative going edge of the same channel.
- and the negative and the negative ((PF) is the differential chan specification applies to device operating temperature range. $s_{sk,PF}$ is the differential channel-to-channel skew of any event between devices. This specification applies to devices at the same V_{CC}, and within 5°C of each other within the



57

5 Test circuit



Figure 3. Timing test circuit, timing and waveforms

Note A: All input pulse are supplied by a generator having the following characteristics: t_r or $t_f \le 1$ ns, pulse repetition rate (PRR) = 50Mpps, pulse width = 10 ± 0.2ns. Note B: C_L includes instrumentation and fixture capacitance within 6mm of the D.U.T.



Figure 4. Enable and disable time test circuit and waveform





STLVDS3486

57

6 Typical performance characteristics



(unless otherwise specified at $T_J = 25^{\circ}C$)

7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Obsolete Product(s) - Obsolete Product(s) Obsolete Product(s) - Obsolete Product(s) Obsolete Product(s) - Obsolete Product(s)

DIM	mm.			inch			
DIM.	MIN.	ТҮР	MAX.	MIN.	MIN. TYP.		
А			1.2			0.047	
A1	0.05		0.15	0.002	0.004	0.006	
A2	0.8	1	1.05	0.031	0.039	0.041	
b	0.19		0.30	0.007		0 012	
С	0.09		0.20	0.004		0.0079	
D	4.9	5	5.1	0.193	0.157	0.201	
Е	6.2	6.4	6.6	0.244	0.252	0.260	
E1	4.3	4.4	4.48	0.1:79	0.173	0.176	
е		0.65 BSC	C	010	0.0256 BSC		
К	0°		C°	0°		8°	
L	0.45	0.60	0.15	0.018	0.024	0.030	



	Tape & Reel TSSOP16 MECHANICAL DATA							
DIM.	mm. inch							
DINI.	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.		
А			330			12.992		
С	12.8		13.2	0.504		0.519		
D	20.2			0.795				
Ν	60			2.362				
Т			22.4			0.802		
Ao	6.7		6.9	0.264		0.272		
Во	5.3		5.5	0.209	90	0.217		
Ко	1.6		1.8	0.063	20	0.071		
Po	3.9		4.1	0.153		0.161		
Р	7.9		8.1	(1.31		0.319		



8 Revision history

Table 7. Revision history

Date	Revision	Changes
06-Apr-2006	4	Order codes has been updated and new template.

Obsolete Product(s) - Obsolete Product(s) Obsolete Product(s) - Obsolete Product(s)



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its study down ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property i gnts is granted under this document. If any part of this document refers to any third party products or services it shall not be doemed a cense grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/CX SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZE REPRESENTATIVE OF ST, ST PRODUCTS ARE NOT DESIGNED, AUTHORIZED OR WARRANTEL FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OF STSTEMS, WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR INVIRONMENTAL DAMAGE.

Resale of S, c or ucts with provisions different from the statements and/or technical features set forth in this document shall immediately void any war ant / granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

